YAMAHA

YSS944/943/940

ADAMB

Advanced Digital Audio Multi channel decode processor

Outline

The YSS944 (ADAMB-f)/YSS943 (ADAMB-b)/YSS940 (ADAMB-nd) is an audio decoding digital signal processor that integrates onto a single chip the various digital signal processing functions required for AV amplifiers, etc. It includes an advanced 32-bit floating-point DSP and is able to decode a variety of audio formats.

[Note]

- The contents described in this manual are implemented by downloading boot firmware.
- For detailed information about the boot firmware, please contact YAMAHA.
- The YSS943 cannot execute DTS-ES and DTS Neo:6 decoding.
- The YSS940 cannot execute any decoding related to DTS (DTS, DTS-ES, DTS 96/24, and DTS Neo:6).

Features

- Supports various types of decoding up to 7.1 channels (5.1/6.1/7.1 channels selectable).
- 5.1-channel decoding of Dolby Digital (AC-3), DTS, AAC.
- 6.1-channel decoding of Dolby Digital EX, DTS-ES.
- DTS 96/24 decoding and audio interface clock division/switching functions.
- Dolby Pro Logic IIx and DTS Neo:6 decoding
- Tone control and bass management functions
- Function modification/expansion by downloading firmware to on-chip memory
- Lip-sync function that enables synchronization of voice and video with variable voice delay
- Supports sampling frequencies up to 192 kHz during PCM playback.
- 1/2 down sampling function when two PCM channels are played back
- Dolby Digital/DTS/AAC decode information output function (can be read by microprocessor)
- High-speed/high-accuracy operation by 32-bit floating-point DSP
 - Operating frequency: 180 MHz (178.176 MHz)
 - Data bus width: 32 bits (24-bit mantissa and 8-bit exponent)
 - Multiplier/adder: 32 bits \times 32 bits + 55 bits \rightarrow 55 bits (47-bit mantissa and 8-bit exponent)
- No external memory needed (external memory is used when delay is increased.)
- Eight general I/O ports
- On-chip PLL for generation of high-speed internal operating clock
- Supply voltage: 1.2 V (core block) and 3.3 V (pin block)
- Low power consumption: about 210 mW (standard value during Dolby Digital decoding)
- Si-gate CMOS process
- Lead-free plating LQFP144 package (YSS944-VZ, YSS943-VZ, and YSS940-VZ)

[Note]

"Dolby," "Dolby Pro Logic IIx," and "AC-3" are trademarks of Dolby Laboratories. "DTS," "DTS-ES," "DTS 96/24," and "DTS Neo:6" are trademarks of Digital Theater Systems, Inc.

Applications

- AV amplifiers for home theaters
- Car audio systems

YAMAHA CORPORATION

YSS944/943/940 CATALOG
CATALOG No.: LSI-4SS944A31
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■ YSS944/943/940 functional comparison

Decoder functional comparison

devise	YSS944	YSS943	YSS940
Dolby Digital	YES	YES	YES
Dolby Digital EX	YES	YES	YES
Dolby Pro Logic IIx	YES	YES	YES
AAC	YES	YES	YES
DTS	YES	YES	NO
DTS 96/24	YES	YES	NO
DTS-ES	YES	NO	NO
DTS Neo:6	YES	NO	NO

YSS944/943/940 common functions

Input channel selection
Volume adjustment
Tone Control
Bass Management
User mute
Auto mute
Input delay
Output delay
Stream detection
Noise generation
Impulse generation
General purpose I/O port

YSS944/943/940

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Block Diagram



Block Name	Function
Cll-Car	This is the internal operating clock generation block.
CikGen	This block provides the PLL and supplies the clock to each block.
MissemIE	This is an interface block to connect to a microprocessor.
MICOIIIF	This block controls access to the registers/memory in this LSI.
SDI	This is the audio interface block for DIR, ADC, etc.
SDI	This block controls the input data format/delay, etc.
SDO	This is the audio interface block for DIT, DAC, etc.
SDO	This block controls the output data format/delay, etc.
Dataatar	This is the stream detection block.
SDO Detector	This block detects the input data encoding format.
EMC	This is an interface block to read from and write to external memory.
EMC	This block implements delay functions using external memory.
	This is an operation processing block.
D	This decoder includes a 32-bit floating-point DSP and memory (ROM or RAM).
Processor	Various functions can be implemented.
	Function modification/expansion by downloading firmware is also supported.



<u>YSS944/943/940</u>

Pin Configuration



< LQFP 144 TOP VIEW >

YSS944/943/940

Pin Functions

Туре	Pin No.	Pin Name	I/O Note 1)	Function
Power supply	9	VDD1	_	Power supply pins for pin block (Typ. 3.3 V).
11.5	33			
	45			
	60			
	85			
	100			
	121			
	136			
	5	VDD2	-	Power supply pins for core block (Typ. 1.2 V).
	6			
	15			
	22			
	23			
	36			
	50			
	51			
	63			
	64			
	70			
	70			
	70			
	80			
	00			
	80			
	05			
	95			
	107			
	108			
	119			
	120			
	127			
	120			
	137			
	130			Down ownly nin 1 for DLL angles block (Trm. 2.2.V)
	142	AVDDK	-	Fower suppry pill 1 for FLL analog block (1yp. 5.5 v). Be sure to insert a 0.1 μ E capacitor between the AVDDR and AVSSR
				ning
	1/13	AHVDD	_	Power supply nin 2 for PLL analog block (Typ. 3.3 V)
	145		_	Be sure to insert a 0.1 <i>J</i> Granacitor between the AHVDD and AHVSS
				nins
	144	AHVDDG	_	Power supply pin 3 for PLL analog block (Typ. 3.3 V)
				Be sure to insert a 0.1 μ capacitor between the AHVDDG and
				AHVSSG pins.
	4	DVDD	-	Power supply pin for PLL digital block (Typ. 1.2 V).
				Be sure to insert a 0.1 μ F capacitor between the DVDD and DVSS
				pins.
	7	VSS	-	Ground pins
	8			*
	14	1		
	20	1		
	21	1		
	35	1		
	41	1		
	42			
	48			
	49			

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Туре	Pin	Pin Name	I/O	Function
	No.		<u>Note 1)</u>	
	61			
	62			
	69			
	77			
	78			
	86			
	87			
	93			
	94			
	105			
	100			
	117			
	123			
	129			
	130			
	139			
	140			
	1	AHVSS		Ground pin 2 for PLL analog block.
				Be sure to insert a 0.1 μ F capacitor between the AHVDD and AHVSS
				pins.
	2	AHVSSG		Ground pin 3 for PLL analog block.
				Be sure to insert a 0.1 μ F capacitor between the AHVDDG and
				AHVSSG pins.
	3	DVSS		Ground pin for PLL digital block.
				Be sure to insert a 0.1 μ F capacitor between the DVDD and DVSS
	1.4.1	AMOOD		pins.
	141	AVSSK		Ground pin 1 for PLL analog block.
				Be sufe to insert a 0.1 μ r capacitor between the AVDDK and AVSSK
Initial clear	131	nIC	Is	Hardware reset input nin
mittur cicur	151	me	15	The LSI is initialized when this pin is at low level.
Clock	18	XI	Ι	Clock input pin.
				Connect this pin as shown in the circuit example <u>Note 2</u>) of the
				12.288 MHz crystal oscillator.
				If not connected to a crystal oscillator, input a 12.288 MHz clock to
				this pin.
	19	XO	0	This is the output pin for the crystal oscillator.
				Connect this pin as shown in the circuit example <u>Note 2</u>).
				If not connected to a crystal oscillator and inputting directly to the XI
				purpose other than clock oscillation
Microprocessor	126	nMICS	Is	This is the microprocessor interface's chin select input pin
interface	120	mmeb	15	Input to the MISCK and MISI pins becomes valid when this pin is at
				low level.
	125	MISCK	Is	This is the microprocessor interface's clock input pin.
	124	MISI	Ι	This is the microprocessor interface's address read/write control and
				data input pin.
	122	MISO	Ot	This is the microprocessor interface's data output pin.
				Connect a pull-up resistor.
Audio interface	32	SDIMCK	Is	This is the master clock input pin for the audio interface's input side.
				The master clock is input from DIR, ADC, etc.
				The night clock frequency that can be input is 25 MHz.
				or lass 256 fs when the frequency is 06 kHz and 128 fs when the
				$\frac{1}{20}$ is when the nequency is $\frac{3}{20}$ KHz, and $\frac{1}{20}$ is when the frequency is up to $\frac{192}{20}$ kHz.
	31	SDIBCK	Is	This is the hit clock I/O nin for the audio interface's input side
	~ 1	221DUK	10	and one of otom a of pair for the utdate interface of input side.

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Туре	Pin No	Pin Name	I/O Note 1)	Function
	INU.			It inputs a 64 fa hit alook
	30	SDIWCK	т	This is the word clock nin for the audio interface's input side
	26	SDIWCK SDI3	I	This is the audio interface's serial data input nin 3
	20	5015	1	If this pin is not used, connect it to a ground
	27	SDI2	T	This is the audio interface's serial data input nin 2
	27	5012	-	If this pin is not used, connect it to a ground.
	28	SDI1	Ι	This is the audio interface's serial data input pin 1.
	-			If this pin is not used, connect it to a ground.
	29	SDI0	Ι	This is the audio interface's serial data input pin 0.
				Connect digital audio data (various streams or PCM) via IEC60958 to
				this pin.
Audio interface	38	SDOMCK	Ot	This is the master clock output pin for the audio interface's output
				side.
				It outputs the master clock to DIT, DAC, etc.
				The highest clock frequency that can be output is 25 MHz.
	34	SDOBCK	Is/O	This is the bit clock I/O pin for the audio interface's output side.
				It inputs or outputs a 64 fs bit clock.
	37	SDOWCK	I/O	This is the word clock pin for the audio interface's output side.
	44	SDO3	0	This is the audio interface's serial data output pin 3.
	43	SDO2	0	This is the audio interface's serial data output pin 2.
	40	SDO1	0	This is the audio interface's serial data output pin 1.
	39	SDO0	0	This is the audio interface's serial data output pin 0.
External memory	112	MEMA18	0	These are external memory address output pins 18 to 0.
interface	58	MEMA17		If external memory is not used, these pins should be left unconnected.
	73	MEMA16		
	72	MEMA15		
	74	MEMA14		
	59	MEMA13		
	75	MEMA12		
	67	MEMA11		
	110	MEMA10		
	66	MEMA9		
	65	MEMA8		
	76	MEMA7		
	81	MEMA6		
	82	MEMA5		
	83	MEMA4		
	84	MEMA3		
	90	MEMA2		
	91	MEMA1		
	92	MEMA0		
	104	MEMD7	I/O	These are external memory data I/O pins 7 to 0.
	103	MEMD6		If external memory is not used, these pins should be left unconnected.
	102	MEMD5		
	101	MEMD4		
	99	MEMD3		
	98	MEMD2		
	97	MEMD1		
	96	MEMD0		
	109	nMEMCE	0	This is the external memory chip select output pin. If external memory is not used, this pin should be left unconnected
	111	nMEMOE	0	This is the external memory output enable output nin
		millinol		If external memory is not used this pin should be left unconnected
	68	nMEMWE	0	This is the external memory write enable output pin
	00		Ĭ	If external memory is not used, this pin should be left unconnected
Status ports	134	nINT	0	This is the interrupt request output pin.



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Туре	Pin	Pin Name	I/O	Function
	No.		<u>Note 1)</u>	
	135	nMUTE	0	This is the output pin during auto mute periods.
	133	ZEROFLG	0	This is the consecutive zero data input detection pin.
	13	STATUS7	0	These are status output pins 7 to 0.
	12	STATUS6		They are used to confirm firmware operations.
	11	STATUS5		Normally, they should be left unconnected.
	10	STATUS4		
	116	STATUS3		
	115	STATUS2		
	114	STATUS1		
	113	STATUS0		
General-purpose	57	IOPORT7	I(+)/O	These are general I/O port pins 7 to 0.
I/O ports	56	IOPORT6		Their I/O status can be set via register settings.
General-purpose	55	IOPORT5	I(+)/O	These are general I/O port pins 7 to 0.
I/O ports	54	IOPORT4		Their I/O status can be set via register settings.
	53	IOPORT3		
	52	IOPORT2		
	47	IOPORT1		
	46	IOPORT0		
Test	16	TEST	Is	Test pins
	17			Connect these pins to a ground.
	24			
	25			
	132			

Note 1) I/O symbols

- I: Input
- Is: Schmitt trigger input
- O: Output
- Ot: Tri-state output
- I/O: I/O
- I(+)/O: Pull-up during input, no pull-up during output

Note 2) Example of circuit connected to crystal oscillator



* The above resistor and capacitor vary depending on the crystal oscillator. Be sure to comply with the specifications of the crystal oscillator used.

Function Description

Functions of the YSS944/943/940 are follows.

(1) Main Decoder Functions

- Dolby Digital decoding
 - Firmware AC3 decoder is included.
 - Supports Annex D.
 - Supports sampling frequencies of 32 kHz, 44.1 kHz, and 48 kHz.
 - 5.1-channel decoding.

• DTS decoding

- Firmware DTS decoder is included.
- Supports DTS-ES Discrete 6.1 decoding. (Sampling frequencies of 44.1 kHz and 48 kHz.)
- Supports DTS 96/24 decoding. (Output sampling frequencies of 88.2 kHz and 96 kHz.)

[Note]

- The YSS943 does not support DTS-ES Discrete 6.1 decoding.
- The YSS940 does not support any DTS decoding.
- AAC decoding
 - Firmware AAC decoder is included.
 - Complies with ARIB digital broadcast standard.
 - Supports ADTS.
 - Supports LC profile.
 - Supported sampling frequencies are 32 kHz, 44.1 kHz, and 48 kHz.
 - 5.1-channel decoding
- PCM 2-channel input playback
 - Firmware PCM2 player is included.
 - Supported sampling frequencies are 32 kHz, 44.1 kHz, 48 kHz, 64 kHz, 88.2 kHz, 96 kHz, 128 kHz, 176.4 kHz, and 192 kHz.
 - Supports 24-bit word length.
 - De-emphasis function.
 - Input DC cutoff function.
 - 1/2 down sampling function.
- PCM 6-/7-/8-channel input playback
 - Firmware PCM8 player is included.
 - Supported sampling frequencies are 32 kHz, 44.1 kHz, 48 kHz, 64 kHz, 88.2 kHz, 96 kHz, 128 kHz, 176.4 kHz, and 192 kHz.
 - Supports 24-bit word length.
 - De-emphasis function.
 - Input DC cutoff function.
 - Audio data input channel control function.

(2) Post Decoder Functions

The following post-decoder function can be applied to the results of main decoder described above.

- Dolby Pro Logic IIx decoding
 - Firmware PL2 decoder is included.
 - Expands to up to 7 channels from 2 channels of L and R.
 - Expands to up to 4 channel from 2 channels of LS and RS (supports Dolby Digital EX with the combination of Dolby Digital decoding function)
 - Supported sampling frequencies are 32 kHz, 44.1 kHz, 48 kHz, 64 kHz, 88.2 kHz, 96 kHz, 176.4 kHz, and 192 kHz.
- DTS Neo:6 decoding
 - Firmware Neo:6 decoder is included.
 - Expands to up to 6 channels from 2 channels of L and R.



- Expands to 3 channels from 2 channels of LS and RS (supports ES Matrix processing when combined with DTS decoding function).
- Supported sampling frequencies are 32 kHz, 44.1 kHz, 48 kHz, 64 kHz, 88.2 kHz, and 96 kHz.

[Note]

- The YSS943 and YSS940 do not support DTS Neo:6 decoding.

(3) Post Processor Functions

The following post-processing function can be applied to the results of main decoder or post decoder.

- Post-processing input channel selection
 - Firmware Switcher is included.
 - Supports 8 channels.
- Tone control
 - Firmware Tone controller is included.
 - Adjustable bass and treble for left and right channels
 - Supported sampling frequencies are 32 kHz, 44.1 kHz, 48 kHz, 64 kHz, 88.2 kHz, 96 kHz, 128 kHz, 176.4 kHz, and 192 kHz.
- Bass Management
 - Firmware Bass manager is included.
 - Characteristics can be changed by changing the coefficient.
 - Up to 7.1-channel input/output.
 - Supported sampling frequencies are 32 kHz, 44.1 kHz, 48 kHz, 64 kHz, 88.2 kHz, 96 kHz, 128 kHz, 176.4 kHz, and 192 kHz.
- Volume adjustment
 - Firmware Scaler is included.
 - Adjustable master volume (setting range: -127 dB to +31 dB, in 1 dB units).
 - Adjustable volume for up to eight channels (- ∞ dB to +12 dB, phase inversion enabled).

(4) Generator Functions

- Noise generation
 - Firmware noise generator is included.
 - Enables generation of pink noise ("shaped noise" in the Dolby standard) and white noise.
 - Supported sampling frequencies are 32 kHz, 44.1 kHz, and 48 kHz.
- Impulse generation
 - Firmware impulse generator is included.
 - Impulses can be generated.
 - Supported sampling frequencies are 32 kHz, 44.1 kHz, and 48 kHz.

(5) Other Functions

- Microprocessor interface
 - This is a four-wire serial interface.
 - Enables register access and on-chip memory access (firmware download).
- Firmware download
 - Instruction code from the microprocessor to this LSI and coefficient data can be downloaded.
 - The amount of 6-/7-/8-channel output delay can be changed.
 - The filter characteristics of the bass management function can be changed.
 - Functions can be expanded for future use.

[Note]

- The boot firmware must be downloaded at initialization.

• Audio interface

- Master clock, bit clock, word clock, and four serial data (8ch) for input and output are provided respectively.
- Various audio interface formats are supported.
- The bit clock rate is fixed to 64 fs.
- Supported sampling frequencies are 32 kHz, 44.1 kHz, 48 kHz, 64 kHz, 88.2 kHz, 96 kHz, 128 kHz, 176.4 kHz, and 192 kHz.
- The bit clock and word clock on the output side have switchable input/output, and can therefore be used as either master or slave.
- A clock divider/switching function is included to enable adjustment of the input/output sampling frequency for DTS 96/24, etc.
- Audio data output channel control
 - Audio output data can be output to any of the channels for the SDO3 to SDO0 pins.
- Bypass
 - Output of SDI data to SDO can bypass the internal core logic.
- User mute
 - Output channels can be muted via the microprocessor interface.
- External memory interface
 - Up to 4 Mb of SRAM can be connected for input delay and/or output delay.
 - Access time can be adjusted via register settings.
- Input delay (lip sync)
 - Input delay for adjusting synchronization between video and audio can be implemented when using external memory.
- Output delay
 - 3-/4-/5-/6-/7-/8-channel output delay with an output sampling frequency of up to 192 kHz can be implemented without using external memory (some exceptions).
 - 3-/4-/5-/6-/7-/8-channel output delay with an output sampling frequency of up to 96 kHz can be implemented using external memory.
- Stream detection
 - Encoding format detection
 - Zero detection
 - Input sampling frequency detection
- Auto mute
 - All channels are muted automatically by detection of noise generation factor.
- Status ports
 - Consecutive-zero data input detection: 1 pin.
 - Auto mute period output: 1 pin.
 - Interrupt request output: 1 pin.
- General purpose I/O port
 - 8 general purpose I/O ports are available.
 - Input and output mode can be switched by register setting.
- Internal operating clock generation
 - Generates the high-speed internal operating clock by on-chip PLL.
- Power-up/power-down
 - Enables power-up/power-down control of the LSI via register settings.



Microprocessor Interface

External microprocessor or similar devices use this microprocessor interface (4-wire serial interface) to perform the following tasks.

- Access to registers
- Firmware download to on-chip memory

(1) Register access

Registers are accessed in 16-bit units via the microprocessor interface. MISI is used to specify the register's address (7 bits: A6 to A0) and the read/write option (1 bit:R/W). During a write operation (R/W=L), data (8 bits: D7 to D0) is input to MISI and during a read operation (R/W=H) 8-bit data is output from the MISO pin. The data to be written is stored in the register at the rising edge of MISCK during the last data bit (D7 in figure).

The microprocessor interface's sequence when accessing registers is shown below.



[Note]

- MISO is in output mode only when nMICS is at low level and during the data (8 bits) output timing. Otherwise, it is in high impedance (High-Z) mode and MISCK, MISI, and MISO can be shared for devices that have a similar interface.
- Registers can be accessed continuously while nMICS remains at low level. There is no need to repeatedly set nMICS to high level.
- Certain register settings enable nMICS to be shared by multiple LSIs.
- Access to on-chip memory (firmware download) is performed by combining with control of writing to a register
- Operation during a hardware reset (when nIC is at low level): During a hardware reset, the microprocessor interface does not function. Also, MISO is fixed at high impedance (High-Z). When nIC is at low level, nMICS should be initialized to high level.
- Interruption of access: Access can be interrupted by setting nMICS to high level. The write operation prior to the 16th rising edge of MISCK (MISI's D7 data capture clock) described above becomes invalid. The MISO pin is set to high impedance (High-Z).

(2) On-chip memory access (firmware download)

Access to on-chip memory is performed in 32-bit units via the microprocessor interface. Also, on-chip memory access can be performed concurrently with register access. The two firmware downloading methods prepared for this LSI are explained below.

(a) Burst transfer mode

When the IA carrier (PRGMOD[1:0] = 11) is used, instruction code/coefficient data firmware can be downloaded in this mode. By using this mode, a large amount of data can be downloaded at high speeds when initialization is executed or when the sampling frequency is changed. The features of the burst transfer mode are as follows.

- During the transfer period, decoding is aborted and data is transferred at high speeds. Muting is automatically effected during the transfer period.
- Data transferred from the microprocessor can be received without handshaking.
- Both instruction code firmware and coefficient data firmware can be downloaded.

The microprocessor interface's sequence in firmware downloading burst transfer mode is shown below.



[Access steps and statuses]

<1> Register setting:

The microprocessor interface function change for the on-chip memory access start address (A in figure) and on-chip memory access is set by register as shown below.

- Set the instruction code firmware download mode (IACNFG = 1)
- Change the firmware program mode to IA carrier (PRGMOD[1:0] = 11).
- Set the on-chip memory access start address IAA[20:0].
- Change the function of the microprocessor interface pin from register access to on-chip memory access (IA = 1).

Once this setting is made, the microprocessor interface functions in firmware downloading burst transfer mode until the nMICS pin is set to high level.

- <2> Start firmware download:
 - The nMICS pin is fixed at low level.
 - Data is transferred LSB first, in 32-bit units.
 - Data is written to on-chip memory when the rising edge of MISCK occurs for the 32nd bit of data (D31 in the figure).
- <3> Continuation and termination of firmware download:
 - Each time 32 bits of data are written, IAA[20:0] is automatically incremented. Accordingly, when writing to consecutive addresses, only the data is transferred.
 - When nMICS changes from low level to high level, firmware download ends and the microprocessor interface returns to accessing registers.
 - When accessing non-consecutive on-chip memory addresses or when resuming firmware downloading after an access interruption, be sure to set IAA[20:0] as described in <1> above.
- <4> When this LSI has not been selected:
- <5> Register setting:
 - After completing a firmware download, perform the following processing.
 - Set the instruction code firmware execution mode (IACNFG = 0).
 - Report the existence of boot firmware to this LSI (DL = 1).
 - Change the firmware program mode PRGMOD[1:0] from "IA carrier" to another mode.



[Note]

Interruption of burst transfer:

- Burst transfer can be interrupted by setting nMICS to high level.
- The write operation becomes invalid when the rising edge of MISCK occurs for the 32nd bit of data (D31 in the figure).
- The MISO pin is set to high impedance (High-Z).

(b) Runtime transfer mode

When the main decoder, noise generator, or impulse generator is used (PRGMOD[1:0] = 00, 01, or 10), the coefficient data firmware can be downloaded in this mode. By using this mode, coefficients such as the amount of 6-/7-/8-channel output delay can be changed without disruption of sound. The features of the runtime transfer mode are as follows.

- Transfer is executed while decoding continues. Muting is not automatically effected during the transfer period.
- One word is transferred at a time while the device is handshaking with the microprocessor.
- Up to 32 words of transfer data are buffered and written all at once to the on-chip memory.
- Downloading coefficient firmware is supported.

[Access steps and statuses]

- <1> Start firmware download:
 - Set the runtime transfer mode and transfer start address by using registers.
 - Initialize the handshake-related registers (RDLFLG = RDLEND = RDLCNT[4:0] = 0).
 - Set the runtime transfer mode (RDLMODE = 1).
 - Set the on-chip memory access start address IAA[20:0].
- <2> Execute firmware download:

One word (32 bits) is downloaded at a time.

- Change the microprocessor interface pin function from register access to on-chip memory access (IA = 1). IAA[20:16] in this byte is valid only when it is set for the first time (for the second and subsequent time, any value may be written).
- Fix nMICS to L.
- Transfer data with the LSB first and in 32-bit units.
- Raise nMICS from L to H.
- Read RDLCNT[4:0].
- Specify starting data transfer (RDLFLG = 1). Set RDLEND to 1 if the transferred data is the last word in successive address transfer; otherwise, clear RDLEND to 0. At this time, write back the value that is read, to RDLCNT[4:0].
- <3> Continuation of firmware download (if RDLEND = 0 in <2>):
 - Confirm the termination of data transfer (RDLFLG = 0).
 - Return to step <2> above.
- <4> Termination of firmware download (if RDLEND = 1 in <2>):
 - Confirm the termination of data transfer/successive address transfer (RDLFLG = RDLEND = 0).
 - Cancel the runtime transfer mode (RDLMODE = 0).

[Note]

- Runtime transfer can be stopped by making nMICS high and clearing RDLMODE to 0.
- Start from <1> if non-successive addresses are transferred or when execution is started again after stopping downloading.
- When the transfer data is captured in the internal buffer, the value of RDLFLG automatically changes from 1 to 0.

If RDLEND = 0 at this time, the transfer data is written only to the internal buffer and not to the transfer destination address.

If RDLEND = 1, the transfer data, along with the data in the internal buffer, is sequentially written from the transfer start address. If data of two or more words, such as filter coefficients, are changed at the same time, transfer them as successive address data.

- Transfer successive address data in the order of the address data that has been incremented starting from the data of the transfer start address.
- Up to 32 words can be transferred as successive address data. If more than 32 words are transferred to successive addresses, start the next transfer from <1> after the first 32 words have been transferred.
- The time until RDLFLG is automatically cleared to 0 after it has been set to 1 varies from 0 to 4 ms.
- Unlike the burst transfer mode, it is not necessary to change IACNFG and PRGMOD[1:0].

(3) Microprocessor interface connection example

When microprocessor interface pins are shared by several LSIs, the target LSI can be selected by either of the following two methods.

• Design nMICS pins dedicated to specific LSIs.

• When nMICS pins are shared by several LSIs, use the ChipAdr register to select the target LSI. These two examples are described below.

(a) Microprocessor interface connection example 1 (single LSI)



- <1> A write operation to ChipAdr as the register access immediately after the falling edge of nMICS is valid.
 - In the above figure, an example of writing when CAE = 0 and CA[3:0] = 4 is illustrated.
- <2> A write operation to ChipAdr as the register access immediately after the falling edge of nMICS is invalid.
- <3> ChipAdr can be read at any time. In this case, the write operation (<2>) is disabled, so the write results from <1> are read.
- <4> Registers cannot be accessed while accessing on-chip memory.



(b) Microprocessor interface connection example 2 (multiple LSIs)



- <1> A write operation to ChipAdr as the register access immediately after the falling edge of nMICS is valid to for all LSIs (chips 2 and 3 in this example) that share the nMICS pin. In this case, CAE = 1 and CA[3:0] = 3, so only the access only for chip 3 is valid.
- <2> A write operation to ChipAdr not immediately after the falling edge of nMICS is also invalid for chip 3.
 - (Chip 2 is not affected by the register access itself.)
- <3> The ChipAdr register can be read at any time. In this case, the write results from <1> are read from chip 3.
 - (Chip 2 is not affected by the register access itself.)
- <4> During on-chip memory access, register access for chip 3 is invalid. (Chip 2 is not affected by on-chip memory access.)
- <5> CAE of all LSIs becomes zero at the rising edge of nMICS.

[Note]

Internal signal nMICS (Chip 3)

The timing by which the chip selection is confirmed in <1> is determined by the value of IOPORT3 to IOPORT0 either at:

- the register access immediately after falling edge of nMICS, or
- a write operation to ChipAdr.

Once the chip selection is confirmed, the current value is retained until the next rising edge of nMICS. Accordingly, even if the selected chip's own IOPORT3 to IOPORT0 values change, the chip does not become deselected immediately.

When nMICS is shared by multiple chips:

- CAE = 0 at the register access immediately after the falling edge of nMICS or CAE = 1 is not written.
- CAE = 1 at the register access immediately after the falling edge of nMICS, but the values of IOPORT3 to IOPORT0 are the same for multiple LSIs.

In the above cases, the multiple LSIs that share nMICS become the selected devices. In such cases, multiple LSIs can be written to at once, but note with caution that a conflict can occur with the MISO output when they are read.

Audio Interface

Input and output of digital audio data is performed via two interfaces:

- SDI (serial data input) interface
- SDO (serial data output) interface

(1) SDI interface format

The following serial data input format is supported via register settings. Regardless of the register setting, the input signals for SDI3 to SDI0 are always handled as fixed-point 24-bit data.



M : MSB DATA L : LSB DATA



(2) SDO interface format

The following serial data output format is supported via register settings.

Regardless of the register setting, the output signals for SDO3 to SDO0 are always handled as fixed-point 24-bit data.



M : MSB DATA L : LSB DATA

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Interrupt Requests

This LSI's status changes by any of the following five factors are externally reported as interrupt requests via the nINT pin.

- <1> When mute status is set by the auto mute function
- <2> When mute status is canceled by the auto mute function
- <3> When decode information is changed
- <4> When the main decoder is changed (MAINMOD[7:0] are changed)
- <5> When the post decoder is changed (POSTMOD[7:0] are changed)

IM register can enable or disable generation of the interrupt of each interrupt factor, and IR register can check generation of and clear an interrupt factor. However, generation of an interrupt factor is not affected by the IM register setting. Changes in the status of this LSI are always detected and reported to IR register.

General Purpose I/O Ports

The general-purpose I/O ports IOPORT7 to IOPORT0 have the following functions. The functions are switched by IOSEL[7:0].

- <1> Input port:
 - Pin statuses are read via IPORT[7:0].
- <2> Output port: Setting values in O
 - Setting values in OPORT[7:0] are output from pins.
- <3> CA comparison port: IOPORT3 to IOPORT0 function as a CA comparison port that is used when nMICS is shared by several LSIs.

A functional outline of IOPORT7 to IOPORT0 is shown below.





Register List

The YSS422/421 is controlled by accessing the following registers via the microcomputer interface (nMICS, MISCK, MISI, and MISO).

Address	Byte Name	R/W	Default Value	D7	D6	D5	D4	D3	D2	D1	D0
0x00	ChipAdr	R/W	0x00	CAE	0	0	0		CA	[3:0]	
0x01	IOsel	R/W	0x00				IOSEL	[7:0]			
0x02	IPort	R	Undefined		IPORT[7:0]						
0x03	OPort	R/W	0x00				OPORT	[7:0]			
0x04	Mute	R/W	0x00	nMUTE_3R	MUTE_3R nMUTE_3L nMUTE_2R nMUTE_2L nMUTE_1R nMUTE_1L nMUTE					nMUTE_0R	nMUTE_0L
0x05	SDIOClk	R/W	0x00	MCKOUT	0	MSE	L[1:0]	WBCKOUT		WBSEL[2:0]	r
0x06	SDI	R/W	0x00	SDISE	EL[1:0]	SDIFN	IT[1:0]	SDIB	T[1:0]	SDIWP	SDIBP
0x07	SDO	R/W	0x00	BYPASS	0	SDOF	AT[1:0]	SDOB	IT[1:0]	SDOWP	SDOBP
0x08	SDOsel0	R/W	0x10	0		SDOSEL_0R[2:)]	0	S	SDOSEL_0L[2:0)]
0x09	SDOsel1	R/W	0x32	0		SDOSEL_1R[2:)]	0	S	SDOSEL_1L[2:0)]
0x0A	SDOsel2	R/W	0x54	0		SDOSEL_2R[2:0)]	0	S	DOSEL_2L[2:0)]
0x0B	SDOsel3	R/W	0x76	0		SDOSEL_3R[2:0)]	0	S	SDOSEL_3L[2:0)]
0x0C	EM0	R/W	0x00	EM_O	EH[1:0]	EM_W	EH[1:0]		EM_C	YC[3:0]	
0x0D	EM1	R/W	0x00	EM_INCLR	0	0		E	M_INSIZE[4:0]		
0x0E	EM2	R/W	0x00	EM_OUTCLR	0	0	ZEDO	EN	1_OUTSIZE[4:	0]	
0x0F	Zero	R/W	0x00	TA	0	0	ZEKU	[/:0]	TA A [20,16]		
0x10	IAU IA1	R/W	0x00	IA	0	0	Ι	5.01	IAA[20:10]		
0x11	IA1 IA2	R/W	0x00								
0x12	IACnfg	R/W	0x00	IACNFG	0	0	0	0	0	0	0
0.14	D (D/IU	0.00	IMMUTE	MIMUTE	MBSCHG	IMMANCHG	IMPOSTCHG	0	0	0
0x14	IM	R/W	0x00		DUNCTE	INDSCHO			0	0	0
0x15	IK	K/W	0x00	nMUTE	IRUMUTE	IKBSCHG	IRMAINCHG	IKPOSICHG		0	
0x10	Ball	R D	0x00	IIWIUTE	0	0	DC[14	IEC01937	Disc	D[1.0]	ZEKUFLU
0x17	Pc0	R D	0x00				PC[1.	·0]			
0x10	FsCnt	R	0x00				FSCNT	.0j [7·0]			
0x17	MainMod	R	0x00				MAINMO	D[7:0]			
0x1B	PostMod	R	0x00				POSTMC	D[7:0]			
0x1C	Stream	R	0x00				STREAM	M[7:0]			
0x1D	PrgMod	R/W	0x00	PRGM	OD[1:0]	0	DTSCDIGN	DSNIGN		DSNSEL[2:0]	
0x1E	Dly0	R/W	0x00	0	0	0	0		DELA	Y[11:8]	
0x1F	Dly1	R/W	0x00				DELAY	<i>[</i> [7:0]			
0x20	Download	R/W	0x00	RDLMODE	0		CHISEL[2:0]		CHCN	FG[1:0]	DL
0x21	OutMode	R/W	0x00	VOLON	0	DUALM	IOD[1:0]		OUTM	OD[3:0]	
0x22	NoiseMode	R/W	0x00	PNWN	0	0	0	0	0	NOISE	FS[1:0]
0x23	NoiseLevel	R/W	0x00				NOISELE	EV[7:0]			
0x24	SDly	R/W	0x00	0	0	0			SDELAY[4:0]		
0x25	CDly	R/W	0x00	0	0	0	0	0		CDELAY[2:0]	
0x26	BSDly	R/W	0x00	0	0		1	BSDELA	Y[5:0]	1	
0x27	Switch	R/W	0x00	RBOUTOFF	LFEOUTOFF	LBOUTOFF	COUTOFF	RSOUTOFF	LSOUTOFF	ROUTOFF	LOUTOFF
0x28	LVolume	R/W	0x00				LVOL	[7:0]			
0x29	RVolume	R/W	0x00				RVOL	[7:0]			
0x2A	LSVolume	R/W	0x00				LSVOL	[7:0]			
0x2B	RSVolume	R/W	0x00				RSVOL	.[/:0]			
0x2C	CVolume	K/W	0x00				CVOL	[/:U] [7:0]			
0x2D	LS Volume	K/W	0x00				LEVOL	ـ[/:۷] [[7:0]			
UA2E	LILVOIUNE	1V/ VV	0100	1			LLEVO	֊լ/.vj			

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0x2E	PPVolumo	D/W	0200	DDV()[[7:0]								
0x21 0x30	MastarValuma	R/W	0x00		MVOL[7:0]							
0x30	I ScaleH	D/W	0x00					[7.0] [15.9]				
0x31	L ScaleI	D/W	0x00				LSCALL	[13.0] [[7:0]				
0x32	PScaleH	D/W	0x00		LOCALE[7.0] RSCALE[15:8]							
0x33	RScaleI	R/W	0x00				RSCALL	5[13.8] F[7:0]				
0x35	I SScaleH	R/W	0x00				ISSCAL	F[15·8]				
0x36	LSScaleI	R/W	0x00				LSSCAL	F[7:0]				
0x37	RSScaleH	R/W	0x00				RSSCAL	F[15·8]				
0x38	RSScaleI	R/W	0x00				RSSCAL	E[13.0]				
0x39	CScaleH	R/W	0x00				CSCALE	S[15:8]				
0x3A	CScaleL	R/W	0x00				CSCAL	E[7:0]				
0x3B	LBScaleH	R/W	0x00				LBSCAL	E[15·8]				
0x3C	LBScaleL	R/W	0x00				LBSCAI	.E[7:0]				
0x3D	LFEScaleH	R/W	0x00				LFESCAI	E[15:8]				
0x3E	LFEScaleL	R/W	0x00				LFESCA	LE[7:0]				
0x3F	RBScaleH	R/W	0x00				RBSCAL	E[15:8]				
0x40	RBScaleL	R/W	0x00				RBSCAI	.E[7:0]				
0x41	SimMode	R/W	0x00	ALLDELAY	DELAYOFF	0	0	0	0	0	0	
0x42	TC	R/W	0x00		BA	SS[3:0]	-		TREBI	LE[3:0]		
0x43	BMMode	R/W	0x00	0	0	0	0	0	0	0	BMMODE	
0x44	HDvnrng	R/W	0x00				HDYNRN	NG[7:0]				
0x45	LDvnrng	R/W	0x00				LDYNRN	IG[7:0]				
0x46	PCMMode0	R/W	0x00	PCMEMPON	PCMDLY	PCMDCCUTON	PCMIGN		PCMF	S[3:0]		
0x47	PCMMode1	R/W	0x00	PCMDS	0	Р	CM20MOD[2:0]		0	0	0	
0x48	AC3Mode0	R/W	0x00	AC3P110FF	AC3DIALOFE	AC3DITHOFF	AC3CRCOFF	AC3KARAOKE	AC3STAUTO	AC3CO	MP[1:0]	
0x49	AC3Mode1	R/W	0x00	0	0		C320MOD[2:0]	RESKINIORE	11050111010	C3\$2MOD[2:()]	
0x44	DTSMode0	R/W	0x00	DTSEX	XT[1:0]	DTSDITHOFF	0	0	0		DTSCOMP	
0x4B	DTSModel	D/W	0x00	0	0	г	0 TS20MOD[2:01	0	T			
0x4D		D/W	0x00		AACMIVSET			0	0	0		
0x4C	AACModel	D/W	0x00	AACIVIIA	AACMIASEI	AACMIALEV	AC20MOD[2:0]	0	0			
0x4D	Deserved	R/W	0x00	0	0	A	AC20MOD[2.0]	0	0 A	ACS2MOD[2.0		
0x4E	Deserved	R/W	0x00	0	0	0	0	0	0	0	0	
0x4F	Reserved	K/W	0.00	0	0	0	0	0	0	0	0	
0x50	Reserved	K/W	000	0	0	0	0	0	0	0	0	
0x51	PL2XMode0	R/W	0x00	PL2XDEC	MOD[1:0]	PL2XINVMAT	PL2XSPLIT	PL2XRSINV	PL2XAIBON	PL2XSR	FIL[1:0]	
0x52	PL2XMode1	R/W	0x00		PL2XDI	MCFG[3:0]		P	L2XCWCFG[2:	0]	0	
0x53	Neo6Mode0	R/W	0x00	N6DECMOD	0	0	0	0	0	0	0	
0x54	Neo6Mode1	R/W	0x00	N6CGAINON			N	6CGAIN[6:0]	r	i	r	
0x55	Reserved	R/W	0x00	0	0	0	0	0	0	0	0	
0x56	RunTime	R/W	0x00	RDLFLG	RDLEND	0			RDLCNT[4:0]			
0x57	Reserved	R/W	0x00	0	0	0	0	0	0	0	0	
0x58	Bitstream0	R/W	0x00			Main	decoder's decode	e information ou	ıtput			
0x59	Bitstream1	R/W	0x00			Main	decoder's decode	e information ou	itput			
0x5A	Bitstream2	R/W	0x00			Main	decoder's decode	e information ou	ıtput			
0x5B	Bitstream3	R/W	0x00			Main	decoder's decode	e information ou	ıtput			
0x5C	Bitstream4	R/W	0x00			Main	decoder's decode	e information ou	itput			
0x5D	Bitstream5	R/W	0x00			Main	decoder's decode	e information ou	itput			
0x5E	Bitstream6	R/W	0x00			Main	aecoder's decod	e information ou	itput			
0x5F	Bitstream7	R/W	0x00		Main decoder's decode information output							
0x60	Bitstream8	R/W	0x00			Main	decoder's decode	e information ou	ıtput			
0x61	Bitstream9	R/W	0x00			Main	decoder's decode	e information ou	ıtput			
0x62	Bitstream10	R/W	0x00			Main	decoder's decode	e information ou	ıtput			
0x63	Bitstream11	R/W	0x00			Main	decoder's decode	e information ou	ıtput			
0x64	Bitstream12	R/W	0x00			Main	decoder's decode	e information ou	ıtput			
0x65	Bitstream13	R/W	0x00			Main	decoder's decode	e information ou	ıtput			

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0x66	Bitstream14	R/W	0x00	Main decoder's decode information output								
0x67	Bitstream15	R/W	0x00		Main decoder's decode information output							
0x68	Bitstream16	R/W	0x00			Main	decoder's decode	e information ou	ıtput			
0x69	Bitstream17	R/W	0x00			Main	decoder's decode	e information ou	ıtput			
0x6A	Bitstream18	R/W	0x00			Main	decoder's decode	e information ou	ıtput			
0x6B	Bitstream19	R/W	0x00			Main	decoder's decode	e information ou	ıtput			
0x6C	Bitstream20	R/W	0x00			Main	decoder's decode	e information ou	ıtput			
0x6D	Test						Access pro	hibited.				
0x6E	Test						Access pro	hibited.				
0x6F	Test						Access pro	hibited.				
0x70	Test						Access pro	hibited.				
0x71	Test						Access pro	hibited.				
0x72	Test						Access pro	hibited.				
0x73	Test				Access prohibited.							
0x74	Test						Access pro	hibited.				
0x75	Test						Access pro	hibited.				
0x76	Test						Access pro	hibited.				
0x77	Test						Access pro	hibited.				
0x78	Test						Access pro	hibited.				
0x79	Test						Access pro	hibited.				
0x7A	PLL0	R/W	0x1B	0				PLL F[6:0]				
0x7B	PLL1	R/W	0x00	PLL C	DD[1:0]	PLL RDIV1			PLL R[4:0]			
0x7C	nReset	R/W	0x00	nRESET	0	0	0		IC[3	3:0]		
0x7D	Power	R/W	0x80	PD[1:0]	0	0	0	0	UP	DOWN	
0x7E	ADAMID	R	0x01 0x00	0	0	0	0	0	l	ADAM_ID[2:0]		
0x7F	DevID	R	0x03				DEV_ID	= 0x03				

[Note]

Register addresses 0x6D to 0x79 comprise a test area. Writing of values to this area is prohibited and read values are undefined.

Access conditions for other addresses are shown below.



(Bold frame) indicates area that is accessible regardless of PD[1:0] value.

(Narrow frame) indicates area that is accessible only when PD[1:0] = 00. When PD[1:0] is not "00" values in this area are undefined when read or written.

(Shaded) indicates areas reserved for future expansion. Write zeros to these areas. Their output is undefined.

Electrical Characteristics

(1) Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit
	VDD1			v
Power supply voltage 1 (3 3 V)	AVDDR	-0.5	4.6	
rower suppry voluge r (5.5 v)	AHVDD	-0.5	ч.0	
	AHVDDG			
Power supply voltage $2(1, 2V)$	VDD2	-0.5	1.68	v
Tower suppry voltage 2 (1.2 V)	DVDD	-0.5	1.00	
Input voltage1 <u>Note 1</u>)	VI	-0.5	5.5	V
Input voltage2 Note 2)	V12	-0.5	4.6	V
Storage temperature	TSTG	-50	125	°C

Condition: All GND pins (VSS, AVSSR, AHVSS, AHVSSG, and DVSS) are 0 V.

Note 1) Applies to input pins other than the X1 pin.

Note 2) Applies to the X1 pin.

(2) Recommended Operating Conditions

Parameter	Symbol	Min.	Тур.	Max.	Unit
	VDD1				
Power supply voltage 1(3.3 V)	AVDDR	3.0	3.3	3.6	V
	AHVDD	5.0			
	AHVDDG				
Power supply voltage $2(1.2 \text{ V})$	VDD2	1 14	1.2	1.26	V
Tower suppry voltage 2(1.2 V)	DVDD	1.17	1.2	1.20	•
Operating temperature	Тор	-40	25	85	°C

Condition: All GND pins (VSS, AVSSR, AHVSS, AHVSSG, and DVSS) are 0 V.

(3) Current Consumption

Parameter	Condition	Min.	Тур.	Max.	Unit
Power consumption	Notes 1 and 4)		211	395	mW
3.3 V current consumption(normal operation mode)	Notes 1, 2, and 4)		13	21	mA
1.2 V current consumption(normal operation mode)	Notes 1, 3, and 4)		140	253	mA
3.3 V current consumption (power-down mode)	Notes 1, 2, 5 and 6)		35	90	μΑ
1.2 V current consumption (power-down mode)	Notes 1, 3, 5, and 6)		15	85	mA

<u>Note 1</u>) Typical values are typical under the recommended operating conditions. Maximum values are the maximum conditions under the recommended operating conditions.

Note 2) Total current of VDD1, AVDDR, AHVDD, and AHVDDG

Note 3) Total current of VDD2 and DVDD

- Note 4) Typical value is at Dloby Digital. Maximum values are at PCM 2-chanel 192kHz+Dolby Pro Logic IIx+Bass Management.
- Note 5) Value in power-down mode 3. XI input is at high level.

Note 6) The current consumption increases during power-down at higher temperatures.

(4) DC Characteristics

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
High level input voltage (1)	$V_{\rm IH1}$	XI pin	0.8VDD1		VDD1	V
Low level input voltage (1)	V_{IL1}	XI pin			0.2VDD1	V
High level input voltage (2)	$V_{\rm IH2}$	Input pin other than XI Note 1)	2.2		5.25	V
Low level input voltage (2)	V_{IL2}	Input pin other than XI Note 1)			0.8	V
High level output voltage	V _{OH}	IOH = -1.0 mA, <u>Note 2)</u>	2.4			V
Low level output voltage	V _{OL}	IOL = 1.0 mA, Note 2)			0.4	V
High level output current	I _{OH}				-1.0	mA
Low level output current	I _{OL}				1.0	mA
Input leakage current	I_{LI}	Pin without pull-up resistor	-1		1	μΑ
Pull-up resistance	$R_{\rm U}$		37		72	kΩ
Input pin's capacitance	CI				7	pF

Note 1) All input pins other than XI are tolerant of 5 V.

Note 2) Applies to all output pins other than XO. No rating for the XO output voltage level.

(5) AC Characteristics

(a) Power up, Hardware Reset, and clock

No.	Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
1	nIC time 1	T _{IC1}	Figure 1) below	5			ms
2	nIC time 2	T _{IC2}	Figure 2) below	1			μs
3	XI clock frequency	f_{XIN}			12.288		MHz
4	XI clock duty	X _{DUTY}		40		60	%
5	Internal operating clock cycle	T _{CLK}	<u>Note 1)</u>		1000/178.176		ns
6	Power ON time	Т	<u>Note 2)</u>	0		1	S
0	I Ower Orv time	• V1V2	<u>Note 3)</u>	1		1	S

<u>Note 1</u>) When using recommended XI input and recommended PLL setting. The internal operating clock frequency is 178.176 MHz.

Note 2) When Shortcut key barrier diode is not connected The 3.3 V power supply (VDD1, AVDDR, AHVDD, and AHVDDG) should be started before the 1.2 V power supply (VDD2 and DVDD).

Note 3) When Shortcut key barrier diode is connected Insert a Shortcut key barrier diode with forward voltage of 0.4 V or less between the 3.3 V power supply (VDD1, AVDDR, AHVDD, and AHVDDG) and 1.2 V power supply (VDD2 and DVDD) (cathode is VDD1 and anode is VDD2).

The 3.3 V power supply and 1.2 V power supply can be started in either order.

<u>Note 4</u>) The time interval of power ON or OFF between 3.3V power supply and 1.2V power supply must be within one second. Only one power keep on supplying, LSI would be damaged.

1) At power-on



- If a crystal oscillator is connected, this includes the time between power supply stabilization and oscillator stabilization.
- Turn on the power when nIC is at low level.

2) In normal operation mode



- The XI input and power supply must be stabilized.
- If XI oscillation has stopped during initialization in power-down mode, time is required to stabilize the oscillation.

(b)Microprocessor interface

No.	Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
1	MISCK cycle	tcc		160			ns
2	MISCK rise time	tcr				20	ns
3	MISCK fall time	tcf				20	ns
4	MISCK high level time	tch		80			ns
5	MISCK low level time	tcl		80			ns
6	nMICS and MISI setup time	tset	<u>Note 1)</u>	10			ns
7	nMICS and MISI hold time	thold	<u>Note 1)</u>	10			ns
8	MISO output delay time	tdelay	CL = 50 pF			50	ns
9	MISO output High-Z time	tz	CL = 50 pF			20	ns

<u>Note 1</u> Satisfy the setup time/hold time (vs. MISCK) on starting/ending transfer, with nMICS = L.



(c) Audio interface

1) SDIMCK

No.	Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
1	SDIMCK input frequency	f _{IMCK}				25	MHz
2	SDIMCK duty	d _{IMCK}			50		%
3	SDIMCK rise time	t _{IMR}				10	ns
4	SDIMCK fall time	t _{IMF}				10	ns



2) SDOMCK

No.	Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
1	SDOMCK output frequency	f _{OMCK}				25	MHz
2	SDOMCK duty	d _{OMCK}	<u>Note 1)</u>		50		%
3	SDOMCK rise time	t _{OMR}	CL = 50 pF			10	ns
4	SDOMCK fall time	t _{OMF}	CL = 50 pF			10	ns

Note 1) When MSEL[1:0] = 00 has been set and "through" has been selected for SDIMCK, the SDOMCK duty factor is affected by the SDIMCK duty factor.



3) SDIBCK, SDIWCK, SDI3 to SDI0 (slave operation)

No.	Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
1	SDIBCK input frequency	f _{IBCK}				12.5	MHz
2	SDIBCK duty	d _{IBCK}	<u>Note 1)</u>		50		%
3	SDIBCK rise time	t _{IBR}				10	ns
4	SDIBCK fall time	t _{IBF}				10	ns
5	SDIWCK and SDI3-0 setup time	t _{IWS}		10			ns
6	SDIWCK and SDI3-0 hold time	t _{IWH}		10			ns

<u>Note 1</u>) The polarity of SDIBCK can be changed by SDIBP. In the figure below, SDIBP = 0.



4) SDOBCK, SDOWCK, SDO3 to SDO0 (slave operation)

No.	Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
1	SDOBCK input frequency	f _{OBCK}				12.5	MHz
2	SDOBCK duty	d _{OBCK}	<u>Note 1)</u>		50		%
3	SDOBCK rise time	t _{OBR}				10	ns
4	SDOBCK fall time	t _{OBF}				10	ns
5	SDOWCK setup time	t _{OWS}		10			ns
6	SDOWCK hold time	t _{OWH}		10			ns
7	SDO3-0 output delay time	t _{ODLY}	CL = 50 pF			30	ns

<u>Note 1</u>) The polarity of SDOBCK can be changed by SDOBP. In the figure below, SDOBP = 0.



5) SDOBCK, SDOW	CK, SDO3 to	SDO0 (maste	er operation)
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No.	Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
1	SDOBCK output frequency	f _{OBCK}	<u>Note 2)</u>			12.5	MHz
2	SDOBCK output duty factor	d _{OBCK}	Notes 1 and 3)		50		%
3	SDOBCK rise time	t _{OBR}	CL = 50 pF			10	ns
4	SDOBCK fall time	t _{OBF}	CL = 50 pF			10	ns
5	SDOWCK, SDO3 to SDO0 Output delay time	t _{ODLY}	CL = 50 pF	-15		15	ns
6	SDIBCK \rightarrow SDOBCK Output delay time	t _{OBDLY}	CL = 50 pF <u>Note 4)</u>	0		25	ns

<u>Note 1</u>) The output polarity of SDIBCK and SDOBCK can be changed by DSIBP and DSOBP. In the figure below, SDOBP = SDOBP = 0.

Note 2) Although output divided from SDIMCK can be selected for SDOBCK via WBSEL[2:0], operation is not guaranteed if SDIMCK's frequency exceeds the range noted above.

<u>Note 3</u> When "SDIBCK through" has been selected (WBSEL[2:0] = 00), the SDDBCK output duty factor is affected by the SDIBCK duty factor.

<u>Note 4</u>) When "SDIBCK through" has been selected (WBSEL[2:0] = 00).



(d)External memory interface

When EM_CYC = c, EM_WEH = w, and EM_OEH = o, the timing is as described below.

1) Read

No.	Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
1	Read cycle time	t _{RCYC}	CL = 20 pF		$t_{ASR^+}t_{REP^+}t_{AHR}$		ns
2	Address access time	t _{AA}	CL = 20 pF			T _{CLK} ×(2c+3)-25	ns
3	nMEMOE access time	t _{EAC}	CL = 20 pF			$T_{CLK} \times (2c+2)-25$	ns
4	Data setup time	t _{DSR}		25			ns
5	Data hold time	t _{DHR}		0			ns
6	Address setup time	t _{ASR}	CL = 20 pF		$T_{CLK} \times 1$		ns
7	Address hold time	t _{AHR}	CL = 20 pF		$T_{CLK} \times (2^{0+1})$		ns
8	nMEMOE pulse width	t _{REP}	CL = 20 pF		$T_{CLK} \times (2c+2)$		ns



2) Write

No.	Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
1	Write cycle time	t _{WCYC}	CL = 20 pF		$T_{CLK} \times (2c+5+2w)$		ns
2	Data setup time	t _{DSW}	CL = 20 pF	0	$T_{CLK} \times (w+1)$		ns
3	Data hold time	t _{DHW}	CL = 20 pF	0	$T_{CLK} \times (w+2)$		ns
4	Address setup time	t _{ASW}	CL = 20 pF		$T_{CLK} \times (w+1)$		ns
5	Address hold time	$t_{\rm AHW}$	CL = 20 pF		$T_{CLK} \times (w+2)$		ns
6	nMEMWE pulse width	t _{WEP}	CL = 20 pF		$T_{CLK} \times (2c+2)$		ns





Example of System Configuration

The YSS944/943/940 is connected to CODEC (ADC/DAC) or DIR/DIT via the audio interface. The YSS944/943/940 is connected to a microprocessor for control via the microcomputer interface. External memory (SRAM) is an option when using the input/output delay function. The YSS944/943/940 can be used with only the internal RAM (without connecting external memory).



YAMAHA

Package Dimensions



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